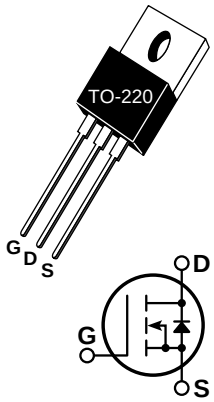
ADVANCED POWER TECHNOLOGY®

APT10026RKVR

1000V 0.48A 26.0Ω

POWER MOS V®

Power MOS V® is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimizes the JFET effect, increases packing density and reduces the on-resistance. Power MOS V® also achieves faster switching speeds through optimized gate layout.



- **Faster Switching**
- **Lower Leakage**
- **100% Avalanche Tested**
- **Popular TO-220 Package**

MAXIMUM RATINGS All Ratings: T_C = 25°C unless otherwise specified.

Symbol	Parameter	APT10026RKVR	UNIT
V_{DSS}	Drain-Source Voltage	1000	Volts
I_D	Continuous Drain Current @ T_C = 25°C	0.48	Amps
I_{DM}	Pulsed Drain Current ①	1.92	
V_{GS}	Gate-Source Voltage Continuous	±30	Volts
V_{GSM}	Gate-Source Voltage Transient	±40	
P_D	Total Power Dissipation @ T_C = 25°C	31	Watts
	Linear Derating Factor	.25	W/°C
T_J,T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	°C
T_L	Lead Temperature: 0.063" from Case for 10 Sec.	300	
I_{AR}	Avalanche Current ① (Repetitive and Non-Repetitive)	TBD	Amps
E_{AR}	Repetitive Avalanche Energy ①	TBD	mJ
E_{AS}	Single Pulse Avalanche Energy ④	TBD	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV_{DSS}	Drain-Source Breakdown Voltage (V_{GS} = 0V, I_D = 250µA)	1000			Volts
$I_{D(on)}$	On State Drain Current② (V_{DS} > $I_{D(on)}$ x $R_{DS(on)}$ Max, V_{GS} = 10V)	0.48			Amps
$R_{DS(on)}$	Drain-Source On-State Resistance② (V_{GS} = 10V, 0.5 $I_{D[Cont.]}$)			26.0	Ohms
I_{DSS}	Zero Gate Voltage Drain Current (V_{DS} = V_{DSS}, V_{GS} = 0V)			25	µA
	Zero Gate Voltage Drain Current (V_{DS} = 0.8 V_{DSS}, V_{GS} = 0V, T_C = 125°C)			250	
I_{GSS}	Gate-Source Leakage Current (V_{GS} = ±30V, V_{DS} = 0V)			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage (V_{DS} = V_{GS}, I_D = 1.0mA)	2		4	Volts

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - http://www.advancedpower.com

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050-5983 Rev - 2-2002

DYNAMIC CHARACTERISTICS

APT10026RKVR

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{iss}	Input Capacitance	V_{GS} = 0V V_{DS} = 25V f = 1 MHz		215		pF
C_{oss}	Output Capacitance			27		
C_{rss}	Reverse Transfer Capacitance			11		
Q_g	Total Gate Charge ③	V_{GS} = 10V V_{DD} = 0.5 V_{DSS} I_D = 20ma @ 25°C		15		nC
Q_{gs}	Gate-Source Charge			1		
Q_{gd}	Gate-Drain ("Miller") Charge			7		
$t_{d(on)}$	Turn-on Delay Time	V_{GS} = 10V V_{DD} = 0.5 V_{DSS} I_D = 20ma @ 25°C R_G = 1.6Ω		9		ns
t_r	Rise Time			11		
$t_{d(off)}$	Turn-off Delay Time			57		
t_f	Fall Time			86		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I_S	Continuous Source Current (Body Diode)			0.48	Amps
I_{SM}	Pulsed Source Current ① (Body Diode)			1.92	
V_{SD}	Diode Forward Voltage ② (V_{GS} = 0V, I_S = -$I_{D[Cont.]}$)			1.3	Volts
t_{rr}	Reverse Recovery Time (I_S = -$I_{D[Cont.]}$, dI_S/dt = 100A/µs)		224		ns
Q_{rr}	Reverse Recovery Charge (I_S = -$I_{D[Cont.]}$, dI_S/dt = 100A/µs)		0.53		µC

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			4.0	°C/W
$R_{\theta JA}$	Junction to Ambient			80	

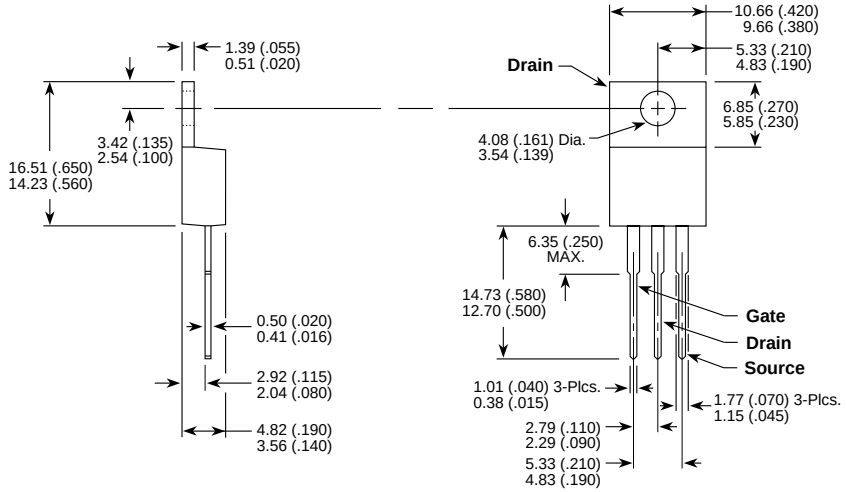
① Repetitive Rating: Pulse width limited by maximum junction temperature.

② Pulse Test: Pulse width < 380 µS, Duty Cycle < 2%

③ See MIL-STD-750 Method 3471

④ Starting T_j = +25°C, L = TBD, R_G = 25Ω, Peak I_L = .48A

TO-220AC Package Outline



Dimensions in Millimeters and (Inches)